



75V N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI®

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
75V	$22m\Omega$ @ V_{GS} = $10V$	7.8A
750	28mΩ @ V_{GS} = 4.5 V	6.9A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Backlighting
- **Power Management Functions**
- DC-DC Converters

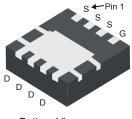
Features and Benefits

- Low R_{DS(ON)} ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI®3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.072 grams (approximate)

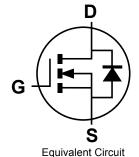
POWERDI®3333-8







Top View



Ordering Information (Note 4)

Part Number	Case	Packaging		
DMN7022LFG-7	POWERDI [®] 3333-8	2,000/Tape & Reel		
DMN7022LFG-13	POWERDI®3333-8	3,000/Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.</p>
 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information



N72= Product Type Marking Code YYWW = Date Code Marking YY = Last digit of year (ex: 13 = 2013) WW = Week code $(01 \sim 53)$



Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	75	V		
Gate-Source Voltage	V _{GSS}	±20	V		
Continuous Dusin Courset (Note CVV - 40V	Steady State	T _A = +25°C T _A = +70°C	I _D	7.8 6.2	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t<10s	T _A = +25°C T _A = +70°C	I _D	10.5 8.4	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	56	Α		
Maximum Continuous Body Diode Forward Current (I _S	2.1	Α		
Avalanche Current, L = 0.1mH			I _{AS}	28.8	Α
Avalanche Energy, L = 0.1mH			E _{AS}	42.2	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 5)		P_{D}	0.9	W
Thermal Decistores It wasting to Ambient (Note 5)	Steady state	-	125	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	67	
Total Power Dissipation (Note 6)		P _D	2	W
Thermal Desigtance, Junction to Ambient (Note 6)	Steady state		62	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	34	
Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	6.9		
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

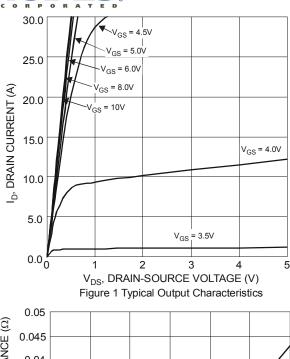
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

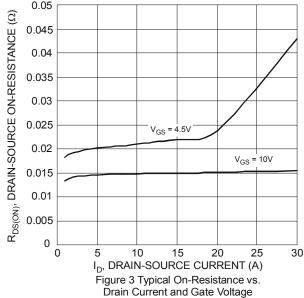
Characteristic		Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	75	_	_	V	$V_{GS} = 0V$, $I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C			_	1	μΑ	$V_{DS} = 75V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}		_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	1	_	3	٧	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance			14.6	22	mΩ	$V_{GS} = 10V, I_D = 7.2A$	
Static Dialii-Source Oil-Resistance	R _{DS(ON)}		20.5	28	11122	$V_{GS} = 4.5V, I_D = 6.4A$	
Diode Forward Voltage	V_{SD}		0.72	_	V	$V_{GS} = 0V, I_{S} = 3.2A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}		2737	_	рF	-	
Output Capacitance	Coss		126	_	pF	$V_{DS} = 35V, V_{GS} = 0V,$ - f = 1MHz	
Reverse Transfer Capacitance	C _{rss}		96.1	_	pF	1 - 1101112	
Gate Resistance	R_g		0.89	_	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz	
Total Gate Charge (V _{GS} = 4.5V)	Q_g		26.4	_	nC		
Total Gate Charge (V _{GS} = 10V)			56.5	_	nC	V _{DS} = 38V, I _D = 7.2A	
Gate-Source Charge	Qgs	l	12	_	nC	VDS = 36V, ID = 7.2A	
Gate-Drain Charge	Q_{gd}	l	11.8	_	nC		
Turn-On Delay Time	t _{D(on)}		6.1	_	ns		
Turn-On Rise Time	t _r		5.7	_	ns	$V_{GS} = 10V, V_{DS} = 38V,$	
Turn-Off Delay Time	t _{D(off)}	-	19.6	_	ns	$R_G = 1\Omega$, $I_D = 5.7A$	
Turn-Off Fall Time	t _f		3.9	_	ns]	
Body Diode Reverse Recovery Time	t _{rr}	_	26.2	_	ns	ns L 5.74 divide 4004/co	
Body Diode Reverse Recovery Charge	Q _{rr}	_	25.2	_	nC	I _F = 5.7A, di/dt = 100A/μs	

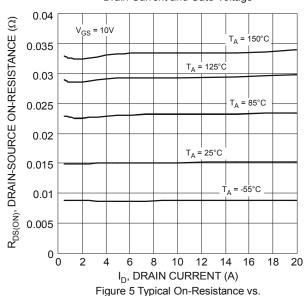
5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.

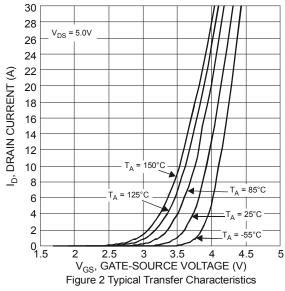


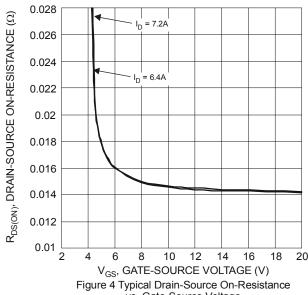


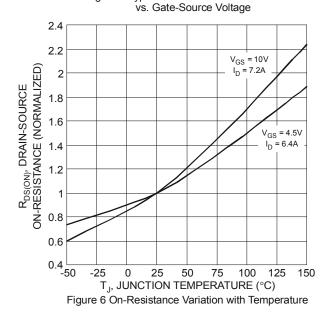




Drain Current and Temperature

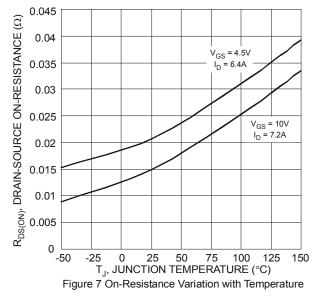


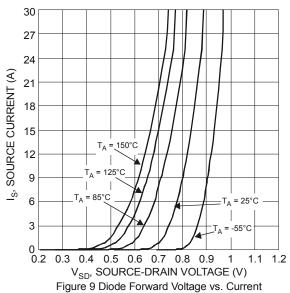


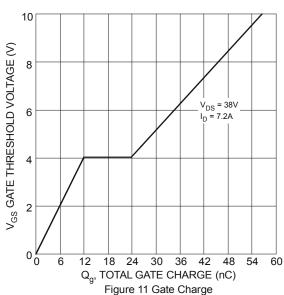


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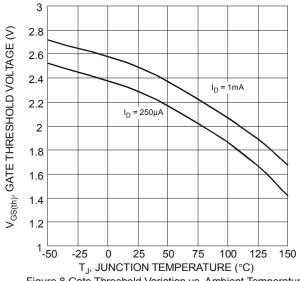
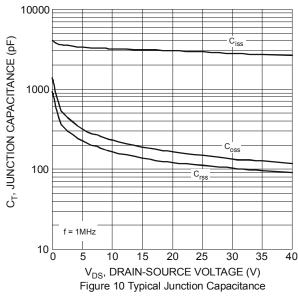
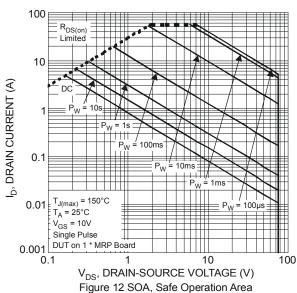
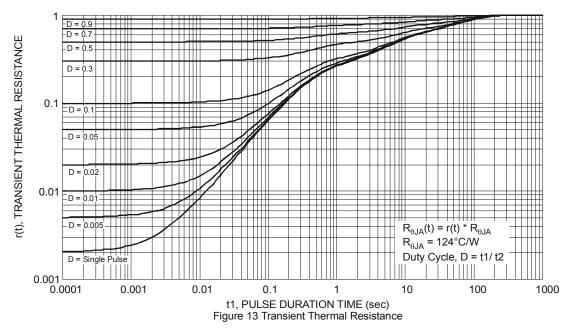


Figure 8 Gate Threshold Variation vs. Ambient Temperature



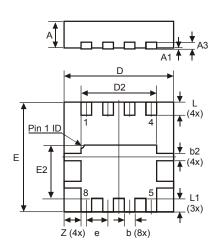






Package Outline Dimensions

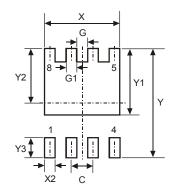
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



POWERDI®3333-8					
Dim	Min	Max	Тур		
D	3.25	3.35	3.30		
Е	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
E2	1.56	1.66	1.61		
Α	0.75	0.85	0.80		
A1	0	0.05	0.02		
A3	_	_	0.203		
b	0.27	0.37	0.32		
b2	_	_	0.20		
L	0.35	0.45	0.40		
L1	_	_	0.39		
е	_	_	0.65		
Z	_	_	0.515		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)				
С	0.650				
G	0.230				
G1	0.420				
Y	3.700				
Y1	2.250				
Y2	1.850				
Y3	0.700				
X	2.370				
X2	0.420				



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